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Details

Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I ² C), UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	8
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	10-VDFDN Exposed Pad
Supplier Device Package	11-QFN (3x3)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f301-gm

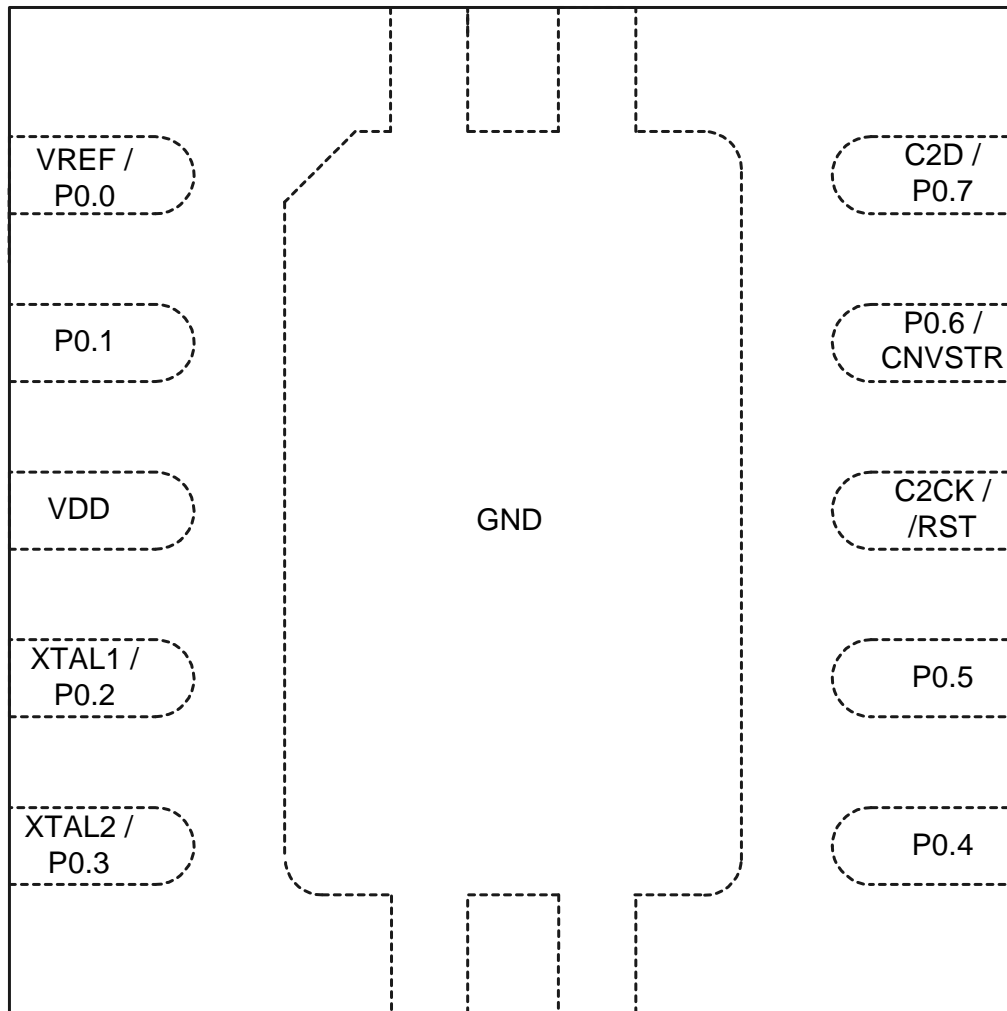


Figure 4.1. QFN-11 Pinout Diagram (Top View)

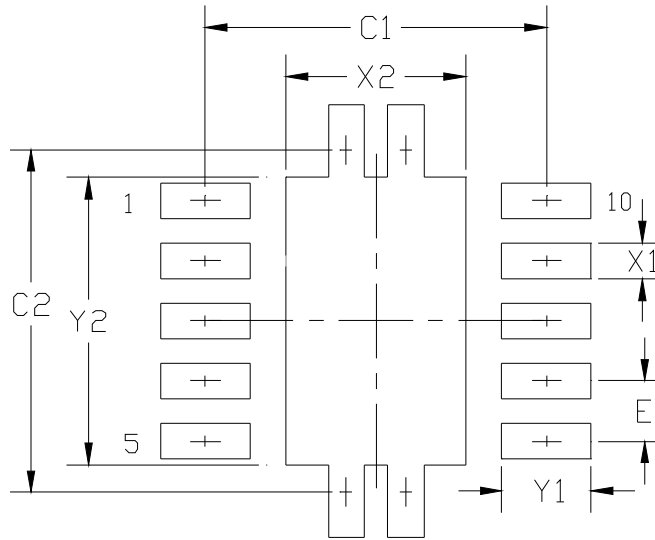


Figure 4.4. Typical QFN-11 Landing Diagram

Table 4.3. QFN-11 Landing Diagram Dimensions

Dimension	MIN	MAX
C1	2.75	2.85
C2	2.75	2.85
E	0.50 BSC	
X1	0.20	0.30
X2	1.40	1.50
Y1	0.65	0.75
Y2	2.30	2.40

Notes: General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This land pattern design is based on the IPC-7351 guidelines.

Notes: Solder Mask Design

1. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.

Notes: Stencil Design

1. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
2. The stencil thickness should be 0.125 mm (5 mils).
3. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
4. A 3 x 1 array of 1.30 x 0.60 mm openings on 0.80 mm pitch should be used for the center ground pad.

Notes: Card Assembly

1. A No-Clean, Type-3 solder paste is recommended.
2. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

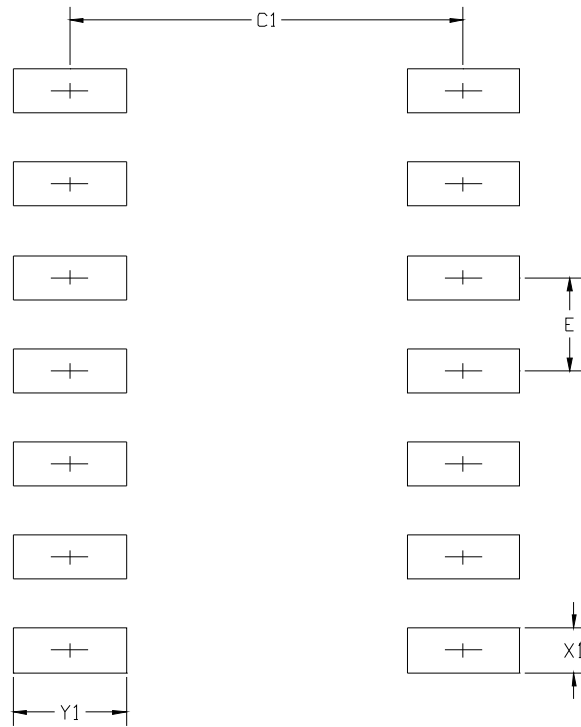


Figure 4.7. SOIC-14 PCB Land Pattern

Table 4.5. SOIC-14 PCB Land Pattern Dimensions

Dimension	Min	Max
C1	5.30	5.40
E	1.27 BSC	
X1	0.50	0.60
Y1	1.45	1.55

C8051F300/1/2/3/4/5

NOTES:

C8051F300/1/2/3/4/5

SFR Definition 7.2. CPT0MX: Comparator0 MUX Selection

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—	—	CMX0N1	CMX0N0	—	—	CMX0P1	CMX0P0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9F

Bits7–6: UNUSED. Read = 00b, Write = don't care.

Bits6–4: CMX0N1–CMX0N0: Comparator0 Negative Input MUX Select.

These bits select which Port pin is used as the Comparator0 negative input.

CMX0N1	CMX0N0	Negative Input
0	0	P0.1
0	1	P0.3
1	0	P0.5
1	1	P0.7

Bits3–2: UNUSED. Read = 00b, Write = don't care.

Bits1–0: CMX0P1–CMX0P0: Comparator0 Positive Input MUX Select.

These bits select which Port pin is used as the Comparator0 positive input.

CMX0P1	CMX0P0	Positive Input
0	0	P0.0
0	1	P0.2
1	0	P0.4
1	1	P0.6

SFR Definition 7.3. CPT0MD: Comparator0 Mode Selection

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—	—	—	—	—	—	CP0MD1	CP0MD0	00000010
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9D

Bits7–2: UNUSED. Read = 000000b, Write = don't care.

Bits1–0: CP0MD1–CP0MD0: Comparator0 Mode Select.

These bits select the response time for Comparator0.

Mode	CP0MD1	CP0MD0	CP0 Response Time (TYP)
0	0	0	Fastest Response Time
1	0	1	—
2	1	0	—
3	1	1	Lowest Power Consumption

C8051F300/1/2/3/4/5

NOTES:

SFR Definition 8.2. DPH: Data Pointer High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x83

Bits7–0: DPH: Data Pointer High.
The DPH register is the high byte of the 16-bit DPTR. DPTR is used to access indirectly addressed Flash memory.

SFR Definition 8.3. SP: Stack Pointer

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x81

Bits7–0: SP: Stack Pointer.
The Stack Pointer holds the location of the top of the stack. The stack pointer is incremented before every PUSH operation. The SP register defaults to 0x07 after reset.

C8051F300/1/2/3/4/5

SFR Definition 8.10. EIP1: Extended Interrupt Priority 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—	—	PCP0R	PCP0F	PPCA0	PADC0C	PWADC0	PSMB0	11000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF6

Bits7–6: UNUSED. Read = 11b. Write = don't care.

Bit5: PCP0R: Comparator0 (CP0) Rising Interrupt Priority Control.
This bit sets the priority of the CP0 rising-edge interrupt.
0: CP0 rising interrupt set to low priority level.
1: CP0 rising interrupt set to high priority level.

Bit4: PCP0F: Comparator0 (CP0) Falling Interrupt Priority Control.
This bit sets the priority of the CP0 falling-edge interrupt.
0: CP0 falling interrupt set to low priority level.
1: CP0 falling interrupt set to high priority level.

Bit3: PPCA0: Programmable Counter Array (PCA0) Interrupt Priority Control.
This bit sets the priority of the PCA0 interrupt.
0: PCA0 interrupt set to low priority level.
1: PCA0 interrupt set to high priority level.

Bit2: PADC0C: ADC0 Conversion Complete Interrupt Priority Control.
This bit sets the priority of the ADC0 Conversion Complete interrupt.
0: ADC0 Conversion Complete interrupt set to low priority level.
1: ADC0 Conversion Complete interrupt set to high priority level.

Bit1: PWADC0: ADC0 Window Comparator Interrupt Priority Control.
This bit sets the priority of the ADC0 Window interrupt.
0: ADC0 Window interrupt set to low priority level.
1: ADC0 Window interrupt set to high priority level.

Bit0: PSMB0: SMBus Interrupt Priority Control.
This bit sets the priority of the SMBus interrupt.
0: SMBus interrupt set to low priority level.
1: SMBus interrupt set to high priority level.

C8051F300/1/2/3/4/5

9.7. Flash Error Reset

If a Flash read/write/erase or program read targets an illegal address, a system reset is generated. This may occur due to any of the following:

- A Flash write or erase is attempted above user code space. This occurs when PSWE is set to '1' and a MOVX operation is attempted above the user code space address limit.
- A Flash read is attempted above user code space. This occurs when a MOVC operation is attempted above the user code space address limit.
- A Program read is attempted above user code space. This occurs when user code attempts to branch to an address above the user code space address limit.

Table 9.1. User Code Space Address Limits

Device	User Code Space Address Limit
C8051F300/1/2/3	0x1DFF
C8051F304	0x0FFF
C8051F305	0x07FF

The FERROR bit (RSTSRC.6) is set following a Flash error reset. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

9.8. Software Reset

Software may force a reset by writing a '1' to the SWRSF bit (RSTSRC.4). The SWRSF bit will read '1' following a software forced reset. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

Table 9.2. Reset Electrical Characteristics

–40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
$\overline{\text{RST}}$ Output Low Voltage	$I_{OL} = 8.5 \text{ mA}$, $V_{DD} = 2.7 \text{ V}$ to 3.6 V	—	—	0.6	V
$\overline{\text{RST}}$ Input High Voltage		$0.7 \times V_{DD}$	—	—	V
$\overline{\text{RST}}$ Input Low Voltage		—	—	$0.3 \times V_{DD}$	
$\overline{\text{RST}}$ Input Leakage Current	$\overline{\text{RST}} = 0.0 \text{ V}$	—	25	40	μA
V_{DD} Monitor Threshold (V_{RST})		2.40	2.55	2.70	V
Missing Clock Detector Timeout	Time from last system clock rising edge to reset initiation	100	220	500	μs
Reset Time Delay	Delay between release of any reset source and code execution at location 0x0000	5.0	—	—	μs
Minimum $\overline{\text{RST}}$ Low Time to Generate a System Reset		15	—	—	μs
V_{DD} Ramp Time	$V_{DD} = 0$ to V_{RST}	—	—	1	ms

C8051F300/1/2/3/4/5

SFR Definition 11.1. OSCICL: Internal Oscillator Calibration

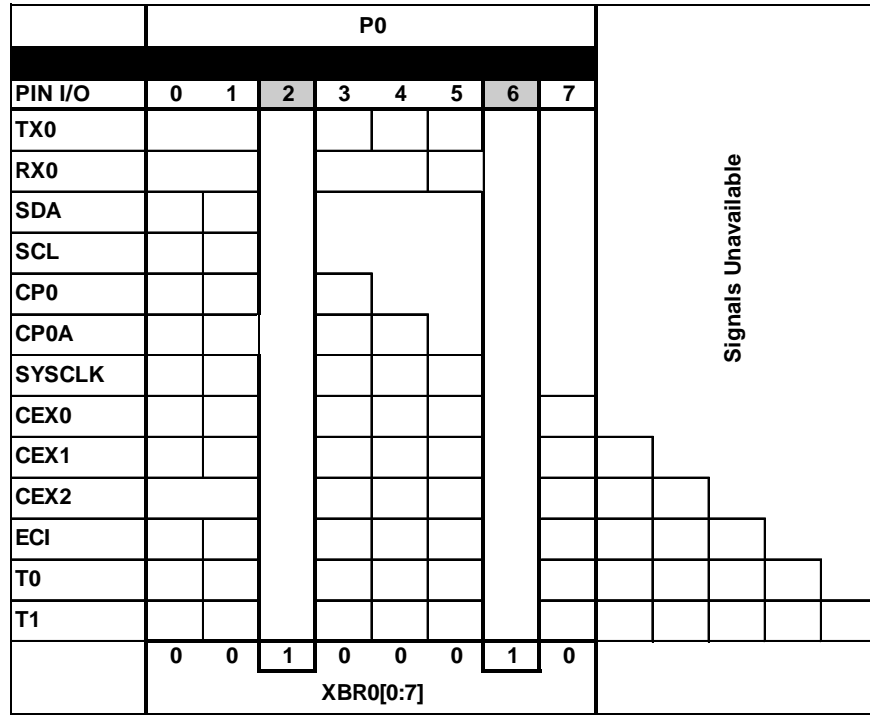
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
—								Variable
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB3

Bit7: UNUSED. Read = 0. Write = don't care.
 Bits 6–0: OSCICL: Internal Oscillator Calibration Register.
 This register calibrates the internal oscillator period. The reset value for OSCICL defines the internal oscillator base frequency. On C8051F300/1 devices, the reset value is factory calibrated to generate an internal oscillator frequency of 24.5 MHz.

SFR Definition 11.2. OSCICN: Internal Oscillator Control

R/W	R/W	R/W	R	R/W	R/W	R/W	R/W	Reset Value
—	—	—	IFRDY	CLKSL	IOSCEN	IFCN1	IFCN0	00010100
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB2

Bits7–5: UNUSED. Read = 000b, Write = don't care.
 Bit4: IFRDY: Internal Oscillator Frequency Ready Flag.
 0: Internal Oscillator is not running at programmed frequency.
 1: Internal Oscillator is running at programmed frequency.
 Bit3: CLKSL: System Clock Source Select Bit.
 0: SYSCLK derived from the Internal Oscillator, and scaled as per the IFCN bits.
 1: SYSCLK derived from the External Oscillator circuit.
 Bit2: IOSCEN: Internal Oscillator Enable Bit.
 0: Internal Oscillator Disabled.
 1: Internal Oscillator Enabled.
 Bits1–0: IFCN1-0: Internal Oscillator Frequency Control Bits.
 00: SYSCLK derived from Internal Oscillator divided by 8.
 01: SYSCLK derived from Internal Oscillator divided by 4.
 10: SYSCLK derived from Internal Oscillator divided by 2.
 11: SYSCLK derived from Internal Oscillator divided by 1.



Port pin potentially available to peripheral
 Port pin skipped by CrossBar
SF Signals Special Function Signals are not assigned by the crossbar. When these signals are enabled, the CrossBar must be manually configured to skip their corresponding port pins. Note: x1 refers to the XTAL1 signal; x2 refers to the XTAL2 signal.

Figure 12.4. Crossbar Priority Decoder with XBR0 = 0x44

Registers XBR1 and XBR2 are used to assign the digital I/O resources to the physical I/O Port pins. Note that when the SMBus is selected, the Crossbar assigns both pins associated with the SMBus (SDA and SCL). Either or both of the UART signals may be selected by the Crossbar. UART0 pin assignments are fixed for bootloading purposes: when UART TX0 is selected, it is always assigned to P0.4; when UART RX0 is selected, it is always assigned to P0.5. Standard Port I/Os appear contiguously after the prioritized functions have been assigned. For example, if assigned functions that take the first 3 Port I/O (P0.[2:0]), 5 Port I/O are left for analog or GPIO use.

C8051F300/1/2/3/4/5

12.2. Port I/O Initialization

Port I/O initialization consists of the following steps:

- Step 1. Select the input mode (analog or digital) for all Port pins, using the Port0 Input Mode register (P0MDIN).
- Step 2. Select the output mode (open-drain or push-pull) for all Port pins, using the Port0 Output Mode register (P0MDOUT).
- Step 3. Set XBR0 to skip any pins selected as analog inputs or special functions.
- Step 4. Assign Port pins to desired peripherals.
- Step 5. Enable the Crossbar.

All Port pins must be configured as either analog or digital inputs. Any pins to be used as Comparator or ADC inputs should be configured as an analog inputs. When a pin is configured as an analog input, its weak pull-up, digital driver, and digital receiver is disabled. This process saves power and reduces noise on the analog input. Pins configured as digital inputs may still be used by analog peripherals; however this practice is not recommended.

Additionally, all analog input pins should be configured to be skipped by the Crossbar (accomplished by setting the associated bits in XBR0). Port input mode is set in the P0MDIN register, where a '1' indicates a digital input, and a '0' indicates an analog input. All pins default to digital inputs on reset. See SFR Definition 12.5 for the P0MDIN register details.

The output driver characteristics of the I/O pins are defined using the Port0 Output Mode register P0MDOUT (see SFR Definition 12.6). Each Port Output driver can be configured as either open drain or push-pull. This selection is required even for the digital resources selected in the XBRn registers, and is not automatic. The only exception to this is the SMBus (SDA, SCL) pins, which are configured as open-drain regardless of the P0MDOUT settings. When the WEAKPUD bit in XBR2 is '0', a weak pull-up is enabled for all Port I/O configured as open-drain. WEAKPUD does not affect the push-pull Port I/O. Furthermore, the weak pull-up is turned off on an open-drain output that is driving a '0' to avoid unnecessary power dissipation.

Registers XBR0, XBR1 and XBR2 must be loaded with the appropriate values to select the digital I/O functions required by the design. Setting the XBARE bit in XBR2 to '1' enables the Crossbar. Until the Crossbar is enabled, the external pins remain as standard digital inputs (output drivers disabled) regardless of the XBRn Register settings. For given XBRn Register settings, one can determine the I/O pin-out using the Priority Decode Table; as an alternative, the Configuration Wizard utility of the Silicon Labs IDE software will determine the Port I/O pin assignments based on the XBRn Register settings.

C8051F300/1/2/3/4/5

14.2.2. 9-Bit UART

9-bit UART mode uses a total of eleven bits per data byte: a start bit, 8 data bits (LSB first), a programmable ninth data bit, and a stop bit. The state of the ninth transmit data bit is determined by the value in TB80 (SCON0.3), which is assigned by user software. It can be assigned the value of the parity flag (bit P in register PSW) for error detection, or used in multiprocessor communications. On receive, the ninth data bit goes into RB80 (SCON0.2) and the stop bit is ignored.

Data transmission begins when an instruction writes a data byte to the SBUF0 register. The T10 Transmit Interrupt Flag (SCON0.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to '1'. After the stop bit is received, the data byte will be loaded into the SBUF0 receive register if the following conditions are met: (1) RI0 must be logic 0, and (2) if MCE0 is logic 1, the 9th bit must be logic 1 (when MCE0 is logic 0, the state of the ninth data bit is unimportant). If these conditions are met, the eight bits of data are stored in SBUF0, the ninth bit is stored in RB80, and the RI0 flag is set to '1'. If the above conditions are not met, SBUF0 and RB80 will not be loaded and the RI0 flag will not be set to '1'. A UART0 interrupt will occur if enabled when either T10 or RI0 is set to '1'.

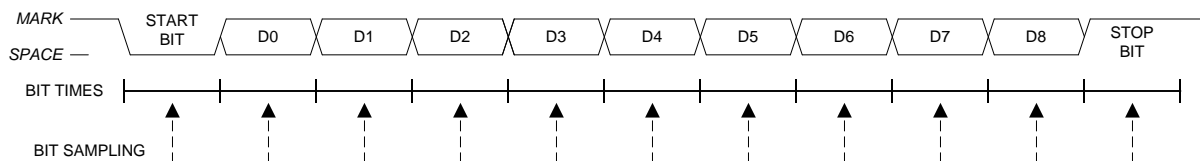


Figure 14.5. 9-Bit UART Timing Diagram

15. Timers

Each MCU includes 3 counter/timers: two are 16-bit counter/timers compatible with those found in the standard 8051, and one is a 16-bit auto-reload timer for use with the ADC, SMBus, or for general purpose use. These timers can be used to measure time intervals, count external events and generate periodic interrupt requests. Timer 0 and Timer 1 are nearly identical and have four primary modes of operation. Timer 2 offers 16-bit and split 8-bit timer functionality with auto-reload.

Timer 0 and Timer 1 Modes:	Timer 2 Modes:
13-bit counter/timer	16-bit timer with auto-reload
16-bit counter/timer	
8-bit counter/timer with auto-reload	Two 8-bit timers with auto-reload
Two 8-bit counter/timers (Timer 0 only)	

Timers 0 and 1 may be clocked by one of five sources, determined by the Timer Mode Select bits (T1M–T0M) and the Clock Scale bits (SCA1–SCA0). The Clock Scale bits define a pre-scaled clock from which Timer 0 and/or Timer 1 may be clocked (See SFR Definition 15.3 for pre-scaled clock selection).

Timer 0/1 may then be configured to use this pre-scaled clock signal or the system clock. Timer 2 may be clocked by the system clock, the system clock divided by 12, or the external oscillator clock source divided by 8.

Timer 0 and Timer 1 may also be operated as counters. When functioning as a counter, a counter/timer register is incremented on each high-to-low transition at the selected input pin. Events with a frequency of up to one-fourth the system clock's frequency can be counted. The input signal need not be periodic, but it should be held at a given level for at least two full system clock cycles to ensure the level is properly sampled.

15.1. Timer 0 and Timer 1

Each timer is implemented as 16-bit register accessed as two separate bytes: a low byte (TL0 or TL1) and a high byte (TH0 or TH1). The Counter/Timer Control register (TCON) is used to enable Timer 0 and Timer 1 as well as indicate their status. Timer 0 interrupts can be enabled by setting the ET0 bit in the IE register (**Section “8.3.5. Interrupt Register Descriptions” on page 75**); Timer 1 interrupts can be enabled by setting the ET1 bit in the IE register (**Section 8.3.5**). Both counter/timers operate in one of four primary modes selected by setting the Mode Select bits T1M1–T0M0 in the Counter/Timer Mode register (TMOD). Each timer can be configured independently. Each operating mode is described below.

15.1.1. Mode 0: 13-bit Counter/Timer

Timer 0 and Timer 1 operate as 13-bit counter/timers in Mode 0. The following describes the configuration and operation of Timer 0. However, both timers operate identically, and Timer 1 is configured in the same manner as described for Timer 0.

The TH0 register holds the eight MSBs of the 13-bit counter/timer. TL0 holds the five LSBs in bit positions TL0.4–TL0.0. The three upper bits of TL0 (TL0.7–TL0.5) are indeterminate and should be masked out or ignored when reading. As the 13-bit timer register increments and overflows from 0x1FFF (all ones) to 0x0000, the timer overflow flag TF0 (TCON.5) is set and an interrupt will occur if Timer 0 interrupts are enabled.

C8051F300/1/2/3/4/5

15.2.2. 8-bit Timers with Auto-Reload

When T2SPLIT is set, Timer 2 operates as two 8-bit timers (TMR2H and TMR2L). Both 8-bit timers operate in auto-reload mode as shown in Figure 15.5. TMR2RLL holds the reload value for TMR2L; TMR2RLH holds the reload value for TMR2H. The TR2 bit in TMR2CN handles the run control for TMR2H. TMR2L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 2 Clock Select bits (T2MH and T2ML in CKCON) select either SYSCLK or the clock defined by the Timer 2 External Clock Select bit (T2XCLK in TMR2CN), as follows:

T2MH	T2XCLK	TMR2H Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

T2ML	T2XCLK	TMR2L Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

Note: External clock divided by 8 is synchronized with the system clock, and the external clock must be less than or equal to the system clock to operate in this mode.

The TF2H bit is set when TMR2H overflows from 0xFF to 0x00; the TF2L bit is set when TMR2L overflows from 0xFF to 0x00. When Timer 2 interrupts are enabled (IE.5), an interrupt is generated each time TMR2H overflows. If Timer 2 interrupts are enabled and TF2LEN (TMR2CN.5) is set, an interrupt is generated each time either TMR2L or TMR2H overflows. When TF2LEN is enabled, software must check the TF2H and TF2L flags to determine the source of the Timer 2 interrupt. The TF2H and TF2L interrupt flags are not cleared by hardware and must be manually cleared by software.

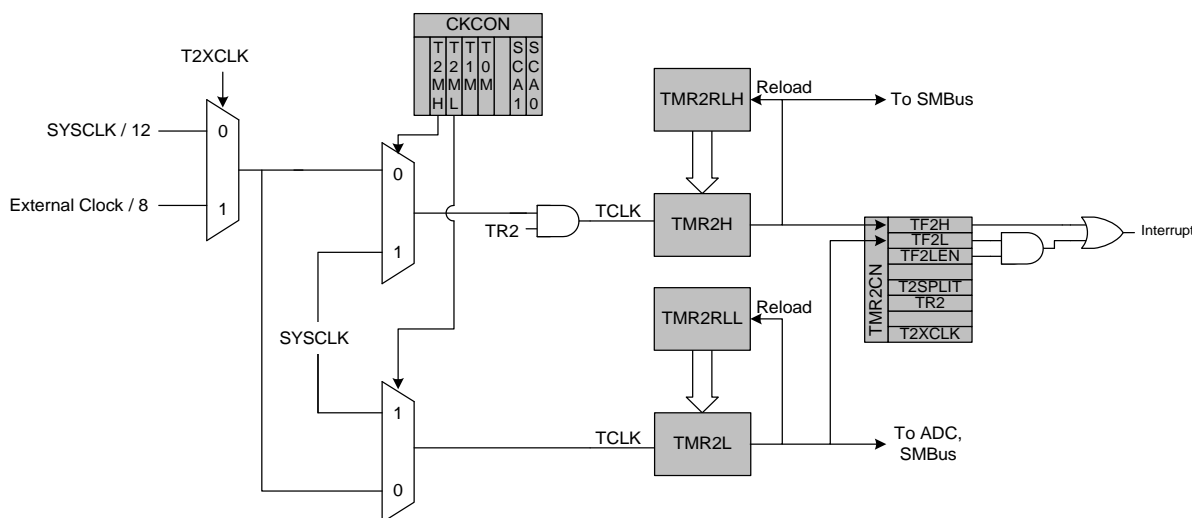


Figure 15.5. Timer 2 8-Bit Mode Block Diagram

C8051F300/1/2/3/4/5

SFR Definition 15.9. TMR2RLL: Timer 2 Reload Register Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCA

Bits 7–0: TMR2RLL: Timer 2 Reload Register Low Byte.
TMR2RLL holds the low byte of the reload value for Timer 2.

SFR Definition 15.10. TMR2RLH: Timer 2 Reload Register High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCB

Bits 7–0: TMR2RLH: Timer 2 Reload Register High Byte.
The TMR2RLH holds the high byte of the reload value for Timer 2.

SFR Definition 15.11. TMR2L: Timer 2 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCC

Bits 7–0: TMR2L: Timer 2 Low Byte.
In 16-bit mode, the TMR2L register contains the low byte of the 16-bit Timer 2. In 8-bit mode, TMR2L contains the 8-bit low byte timer value.

SFR Definition 15.12. TMR2H Timer 2 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCD

Bits 7–0: TMR2H: Timer 2 High Byte.
In 16-bit mode, the TMR2H register contains the high byte of the 16-bit Timer 2. In 8-bit mode, TMR2H contains the 8-bit high byte timer value.

16. Programmable Counter Array

The Programmable Counter Array (PCA0) provides enhanced timer functionality while requiring less CPU intervention than the standard 8051 counter/timers. The PCA consists of a dedicated 16-bit counter/timer and three 16-bit capture/compare modules. Each capture/compare module has its own associated I/O line (CEXn) which is routed through the Crossbar to Port I/O when enabled (See **Section “12.1. Priority Crossbar Decoder”** on page 104 for details on configuring the Crossbar). The counter/timer is driven by a programmable timebase that can select between six sources: system clock, system clock divided by four, system clock divided by twelve, the external oscillator clock source divided by 8, Timer 0 overflow, or an external clock signal on the ECI input pin. Each capture/compare module may be configured to operate independently in one of six modes: Edge-Triggered Capture, Software Timer, High-Speed Output, Frequency Output, 8-Bit PWM, or 16-Bit PWM (each mode is described in **Section “16.2. Capture/Compare Modules”** on page 157). The external oscillator clock option is ideal for real-time clock (RTC) functionality, allowing the PCA to be clocked by a precision external oscillator while the internal oscillator drives the system clock. The PCA is configured and controlled through the system controller's Special Function Registers. The basic PCA block diagram is shown in Figure 16.1.

Important Note: The PCA Module 2 may be used as a watchdog timer (WDT), and is enabled in this mode following a system reset. Access to certain PCA registers is restricted while WDT mode is enabled. See **Section 16.3** for details.

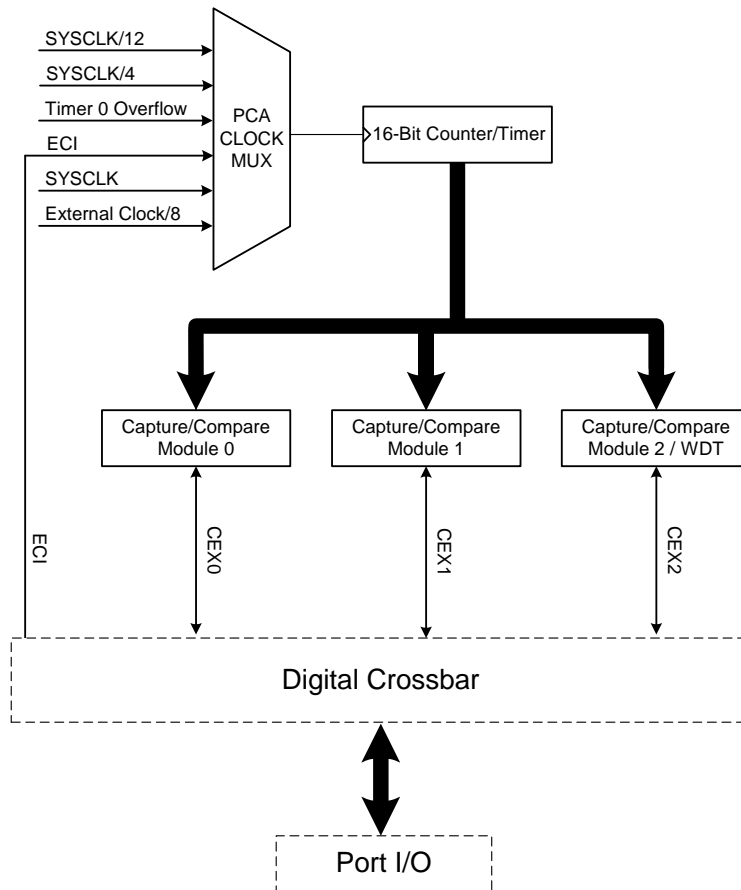


Figure 16.1. PCA Block Diagram

C8051F300/1/2/3/4/5

16.1. PCA Counter/Timer

The 16-bit PCA counter/timer consists of two 8-bit SFRs: PCA0L and PCA0H. PCA0H is the high byte (MSB) of the 16-bit counter/timer and PCA0L is the low byte (LSB). Reading PCA0L automatically latches the value of PCA0H into a “snapshot” register; the following PCA0H read accesses this “snapshot” register. **Reading the PCA0L Register first guarantees an accurate reading of the entire 16-bit PCA0 counter.** Reading PCA0H or PCA0L does not disturb the counter operation. The CPS2-CPS0 bits in the PCA0MD register select the timebase for the counter/timer as shown in Table 16.1. **Note that in ‘External oscillator source divided by 8’ mode, the external oscillator source is synchronized with the system clock, and must have a frequency less than or equal to the system clock.**

When the counter/timer overflows from 0xFFFF to 0x0000, the Counter Overflow Flag (CF) in PCA0MD is set to logic 1 and an interrupt request is generated if CF interrupts are enabled. Setting the ECF bit in PCA0MD to logic 1 enables the CF flag to generate an interrupt request. The CF bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software (Note: PCA0 interrupts must be globally enabled before CF interrupts are recognized. PCA0 interrupts are globally enabled by setting the EA bit and the EPCA0 bit to logic 1). Clearing the CIDL bit in the PCA0MD register allows the PCA to continue normal operation while the CPU is in Idle mode.

Table 16.1. PCA Timebase Input Options

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12
0	0	1	System clock divided by 4
0	1	0	Timer 0 overflow
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4)
1	0	0	System clock
1	0	1	External oscillator source divided by 8*

*Note: External oscillator source divided by 8 is synchronized with the system clock.

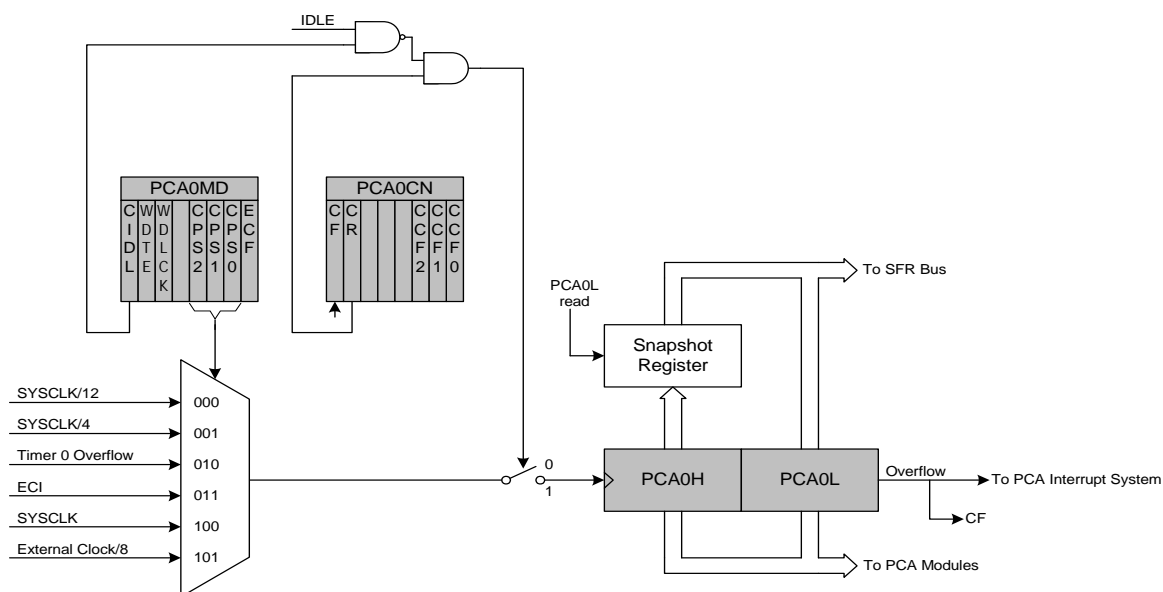


Figure 16.2. PCA Counter/Timer Block Diagram

16.2.6. 16-Bit Pulse Width Modulator Mode

A PCA module may also be operated in 16-bit PWM mode. In this mode, the 16-bit capture/compare module defines the number of PCA clocks for the low time of the PWM signal. When the PCA counter matches the module contents, the output on CEXn is set to '1'; when the counter overflows, CEXn is set to '0'. To output a varying duty cycle, new value writes should be synchronized with PCA CCFn match interrupts. 16-bit PWM Mode is enabled by setting the ECOMn, PWMn, and PWM16n bits in the PCA0CPMn register. For a varying duty cycle, match interrupts should be enabled (ECCFn = 1 AND MATn = 1) to help synchronize the capture/compare register writes. The duty cycle for 16-bit PWM Mode is given by Equation 16.3.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to '0'; writing to PCA0CPHn sets ECOMn to '1'.

$$DutyCycle = \frac{(65536 - PCA0CPn)}{65536}$$

Equation 16.3. 16-Bit PWM Duty Cycle

Using Equation 16.3, the largest duty cycle is 100% (PCA0CPn = 0), and the smallest duty cycle is 0.0015% (PCA0CPn = 0xFFFF). A 0% duty cycle may be generated by clearing the ECOMn bit to '0'.

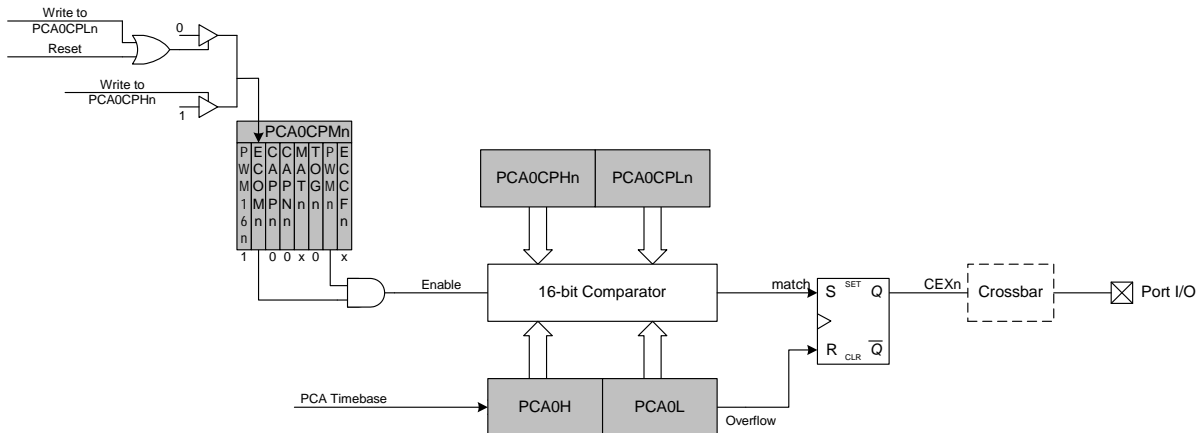


Figure 16.9. PCA 16-Bit PWM Mode

17. C2 Interface

C8051F300/1/2/3/4/5 devices include an on-chip Silicon Labs 2-Wire (C2) debug interface to allow Flash programming and in-system debugging with the production part installed in the end application. The C2 interface operates using only two pins: a bi-directional data signal (C2D) and a clock input (C2CK). See the C2 Interface Specification for details on the C2 protocol.

17.1. C2 Interface Registers

The following describes the C2 registers necessary to perform Flash programming functions through the C2 interface. All C2 registers are accessed through the C2 interface as described in the C2 Interface Specification.

C2 Register Definition 17.1. C2ADD: C2 Address

									Reset Value
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	00000000	

Bits7–0: The C2ADD register is accessed via the C2 interface to select the target Data register for C2 Data Read and Data Write commands.

Address	Description
0x00	Selects the Device ID register for Data Read instructions
0x01	Selects the Revision ID register for Data Read instructions
0x02	Selects the C2 Flash Programming Control register for Data Read/Write instructions
0xB4	Selects the C2 Flash Programming Data register for Data Read/Write instructions
0x80	Selects the Port0 register for Data Read/Write instructions
0xF1	Selects the Port0 Input Mode register for Data Read/Write instructions
0xA4	Selects the Port0 Output Mode register for Data Read/Write instructions

C2 Register Definition 17.2. DEVICEID: C2 Device ID

									Reset Value
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	00000100	

This read-only register returns the 8-bit device ID: 0x04 (C8051F300/1/2/3/4/5).